

UTC UNISONIC TECHNOLOGIES CO., LTD

4N65-TC1 Power MOSFET

4A, 650V **N-CHANNEL POWER MOSFET**

DESCRIPTION

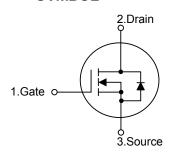
The UTC 4N65-TC1 is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC 4N65-TC1 is generally applied in high efficiency switch mode power supplies.



- * $R_{DS(ON)} \le 2.7\Omega$ @ $V_{GS} = 10V$, $I_D = 2.0A$
- * High Switching Speed

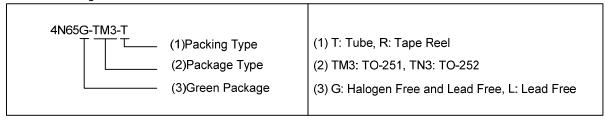
SYMBOL



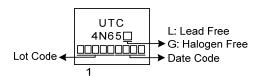
ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
4N65L-TM3-T	4N65G-TM3-T	TO-251	G	D	S	Tube	
4N65L-TN3-R	4N65G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



TO-251 TO-252

www.unisonic.com.tw 1 of 8 4N65-TC1 Power MOSFET

■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	650	V
Gate-Source Voltage		V_{GSS}	± 30	V
Drain Current	Continuous	I_{D}	4	Α
	Pulsed (Note 2)	I_{DM}	8	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	105	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.45	V/ns
Power Dissipation		P _D	50	W
Junction Temperature		T _J	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 10mH, I_{AS} = 4.6A, V_{DD} = 50V, R_G = 25 Ω Starting T_J = 25°C
- 4. $I_{SD} \le 4.0A$, di/dt $\le 100A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	θ _{JA} 110		
Junction to Case	θ_{JC}	2.5 (Note)	°C/W	

Note: Device mounted on FR-4 substrate P_C board, 2oz copper, with 1inch square copper plate.

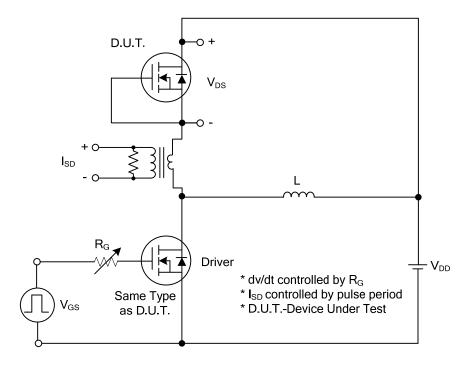
■ ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D = 250μA	650			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =650V, V _{GS} =0V			10	μA
Onto Common London of Commont	Forward	I _{GSS}	V _{GS} =30V, V _{DS} =0V			100	nA
Gate-Source Leakage Current	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =2.0A			2.7	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance Output Capacitance		C_{ISS}			532		pF
		Coss	V_{GS} =0V, V_{DS} =25V, f=1.0 MHz		57		pF
Reverse Transfer Capacitance		C_{RSS}			3.5		pF
SWITCHING CHARACTERISTICS	S						
Total Gate Charge (Note 1)		Q_G	\/ -F20\/ \/ -10\/ \ -4A		15		nC
Gateource Charge		Q_{GS}	V_{DS} =520V, V_{GS} =10V, I_{D} =4A I_{G} =1mA (Note 1, 2)		4.9		nC
Gate-Drain Charge		Q_GD	IG-IIIA (Note 1, 2)		3		nC
Turn-on Delay Time (Note 1)		t _{D(ON)}			5.6		ns
Rise Time		t_R	V_{DS} =100V, V_{GS} =10V, I_{D} =4A,		16.5		ns
Turn-off Delay Time		$t_{D(OFF)}$	R _G =25Ω (Note 1, 2)		37		ns
Fall-Time		t_{F}			26.5		ns
SOURCE- DRAIN DIODE RATING	SS AND CH	ARACTERIS'	TICS				
Maximum Continuous Drain-Source Diode		Is				4	Α
Forward Current						4	А
Maximum Pulsed Drain-Source Diode		I _{SM}				8	Α
Forward Current						0	^
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =4A, V _{GS} =0V			1.4	V
Reverse Recovery Time (Note 1)		t _{rr}	I _S =4A, V _{GS} =0V		332		ns
Reverse Recovery Charge		Q_{rr}	dI _F /dt=100A/μs (Note1)		1.7		μC

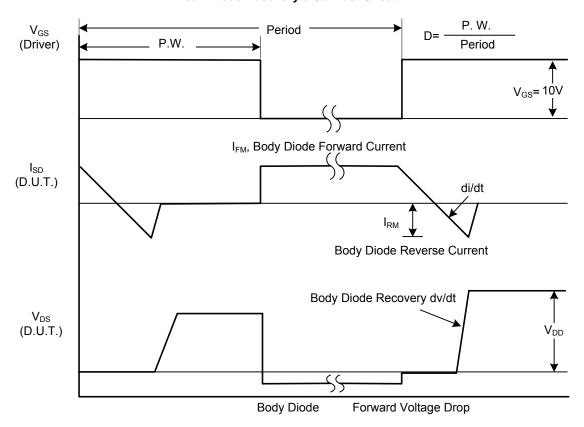
Notes: 1. Pulse Test : Pulse width \leq 300 μ s, Duty cycle \leq 2%.

^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



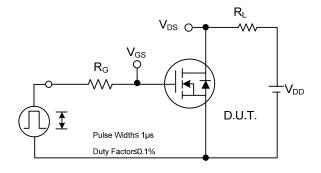
Peak Diode Recovery dv/dt Test Circuit

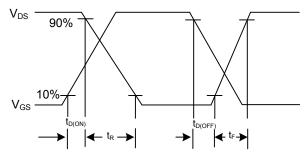


Peak Diode Recovery dv/dt Waveforms

4N65-TC1 Power MOSFET

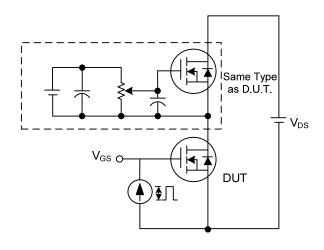
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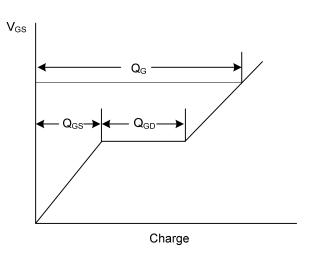




Switching Test Circuit

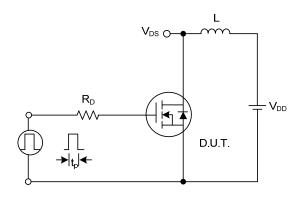
Switching Waveforms

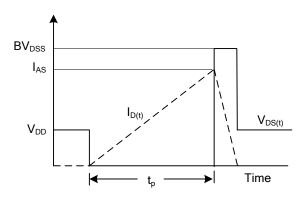




Gate Charge Test Circuit

Gate Charge Waveform

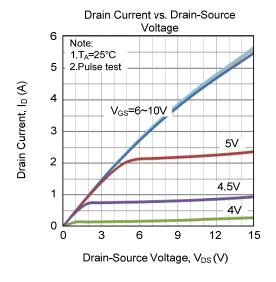


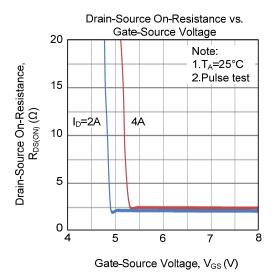


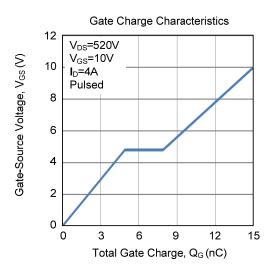
Unclamped Inductive Switching Test Circuit

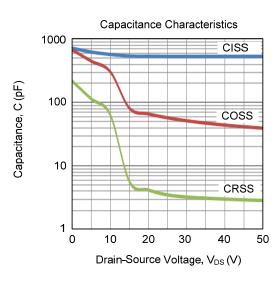
Unclamped Inductive Switching Waveforms

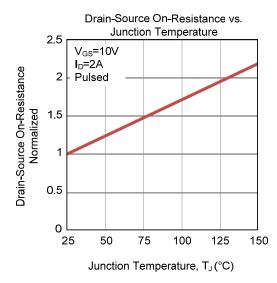
■ TYPICAL CHARACTERISTICS

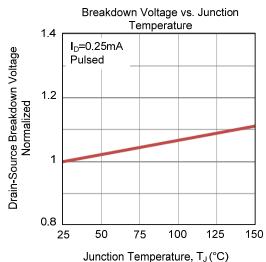




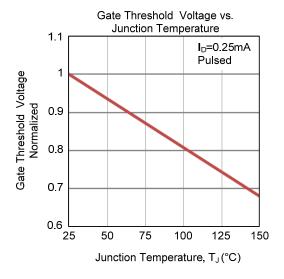


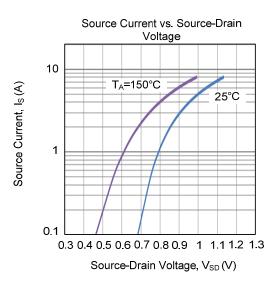


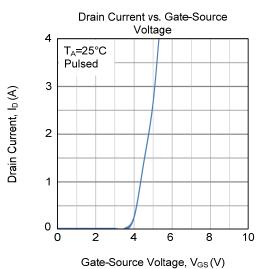


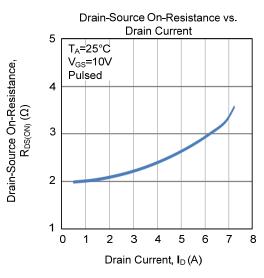


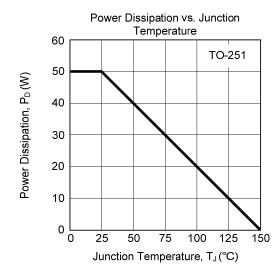
■ TYPICAL CHARACTERISTICS (Cont.)

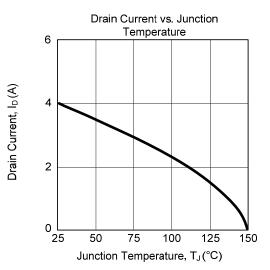




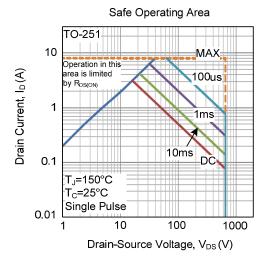








■ TYPICAL CHARACTERISTICS (Cont.)



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